

2SK2225

1500V - 2A - MOS FET
High Speed Power Switching

勝特力材料 886-3-5753170
胜特力电子(上海) 86-21-34970699
胜特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

Application

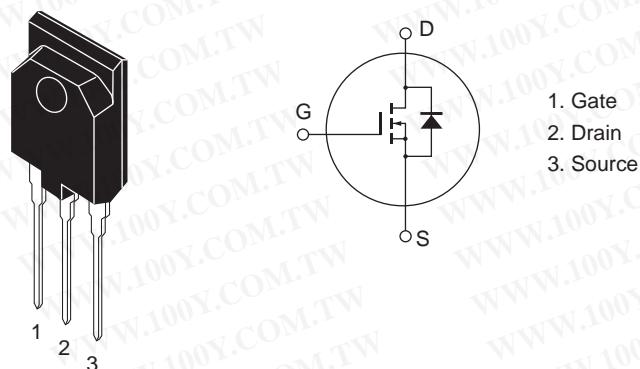
High speed power switching

Features

- High breakdown voltage ($V_{DSS} = 1500$ V)
- High speed switching
- Low drive current
- No Secondary breakdown
- Suitable for switching regulator, DC-DC converter

Outline

RENESAS Package code: PRSS0003ZA-A
(Package name: TO-3PFM)



Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	1500	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	2	A
Drain peak current	$I_{D(\text{pulse})}^{*1}$	7	A
Body to drain diode reverse drain current	I_{DR}	2	A
Channel dissipation	P_{ch}^{*2}	50	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: 1. $PW \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$

2. Value at $T_c = 25^\circ\text{C}$

Electrical Characteristics

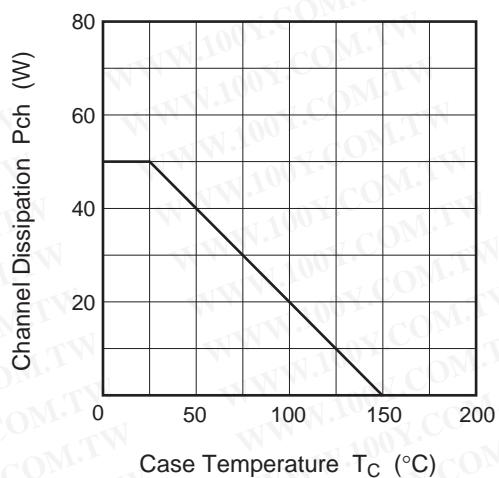
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	1500	—	—	V	I _D = 10 mA, V _{GS} = 0
Gate to source leak current	I _{GSS}	—	—	±1	μA	V _{GS} = ±20 V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	500	μA	V _{DS} = 1200 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	2.0	—	4.0	V	I _D = 1 mA, V _{DS} = 10 V
Static drain to source on state resistance	R _{DSS(on)}	—	9	12	Ω	I _D = 1 A, V _{GS} = 15 V*3
Forward transfer admittance	y _{fs}	0.45	0.75	—	S	I _D = 1 A, V _{DS} = 20 V*3
Input capacitance	C _{iss}	—	990	—	pF	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz
Output capacitance	C _{oss}	—	125	—	pF	
Reverse transfer capacitance	C _{rss}	—	60	—	pF	
Turn-on delay time	t _{d(on)}	—	17	—	ns	I _D = 1 A, V _{GS} = 10 V, R _L = 30 Ω
Rise time	t _r	—	50	—	ns	
Turn-off delay time	t _{d(off)}	—	150	—	ns	
Fall time	t _f	—	50	—	ns	
Body to drain diode forward voltage	V _{DF}	—	0.9	—	V	I _F = 2 A, V _{GS} = 0
Body to drain diode reverse recovery time	t _{rr}	—	1750	—	ns	I _F = 2 A, V _{GS} = 0, dI _F / dt = 100 A / μs

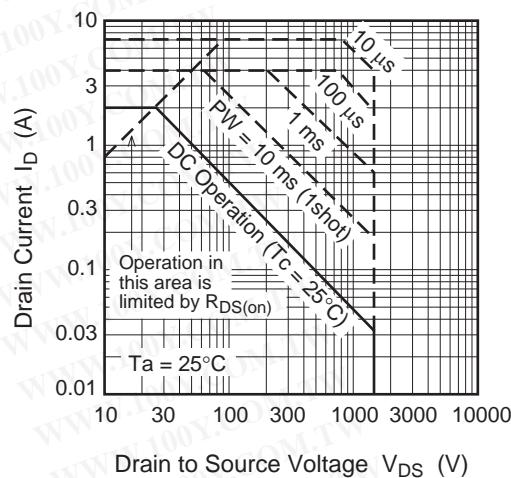
Note: 3. Pulse Test

Main Characteristics

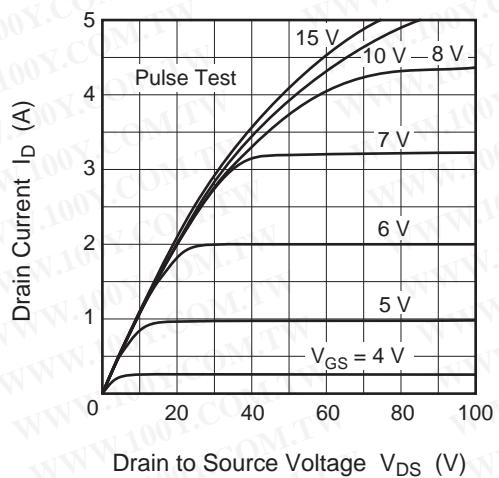
Power vs. Temperature Derating



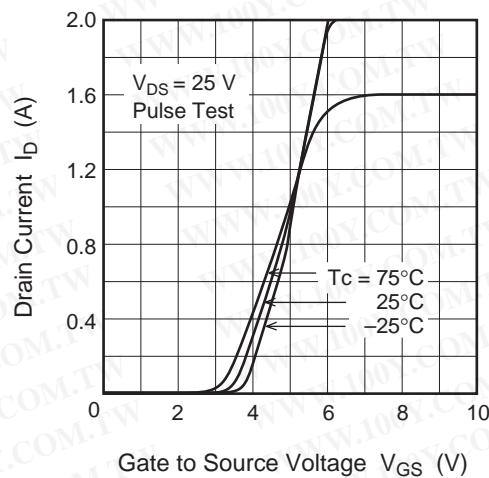
Maximum Safe Operation Area



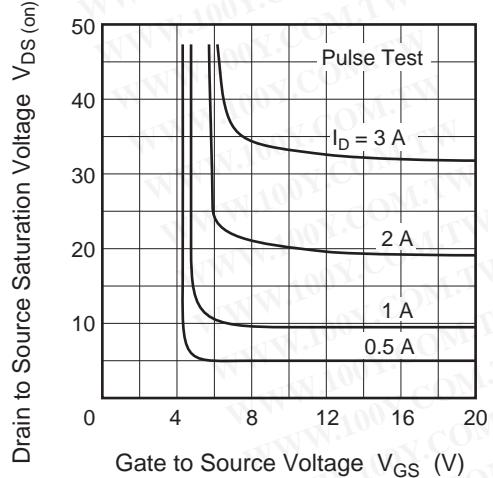
Typical Output Characteristics



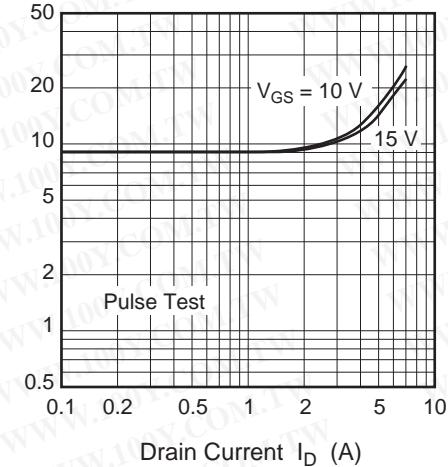
Typical Transfer Characteristics

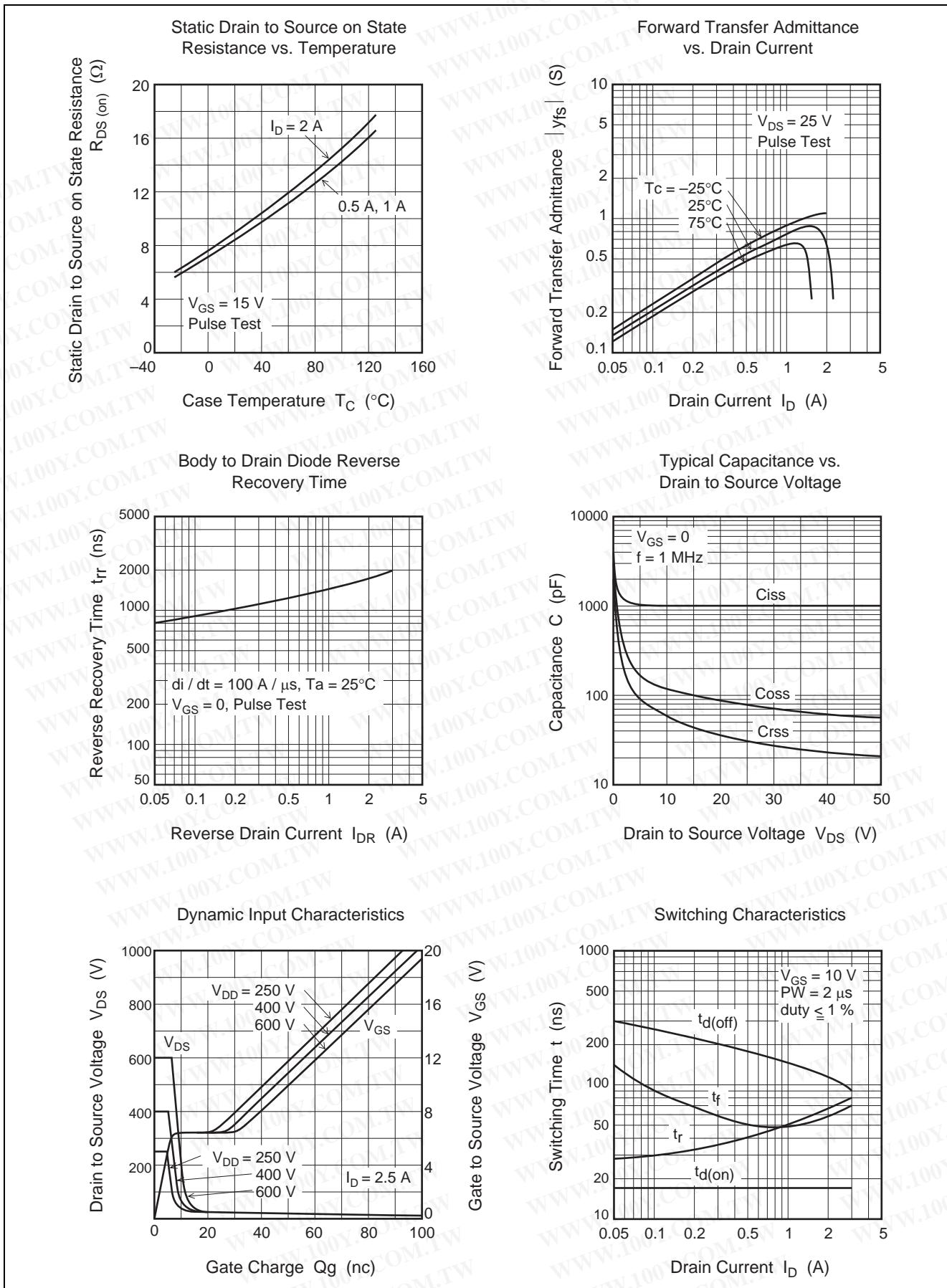


Drain to Source Saturation Voltage vs. Gate to Source Voltage

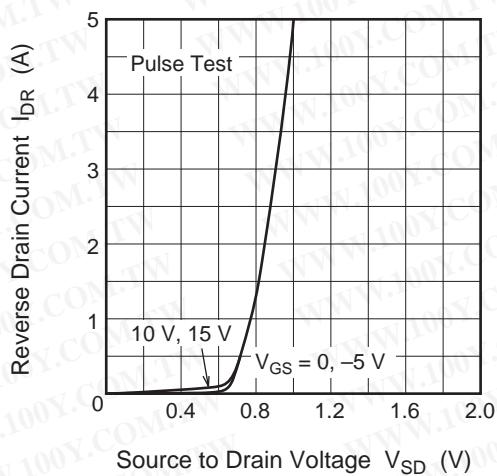


Static Drain to Source on State Resistance vs. Drain Current

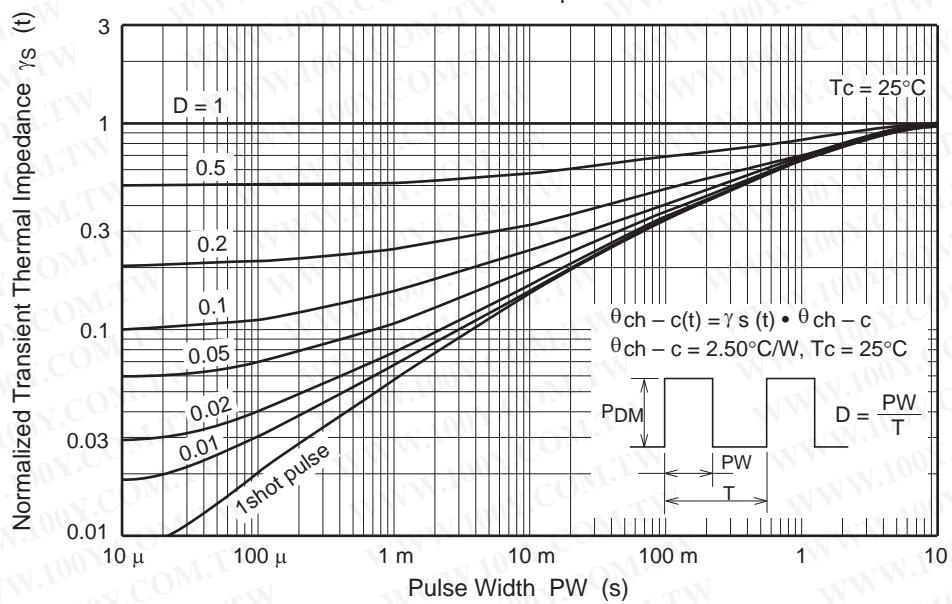




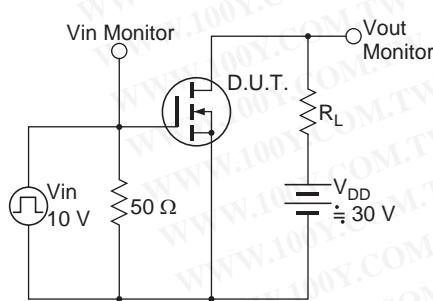
Reverse Drain Current vs.
Source to Drain Voltage



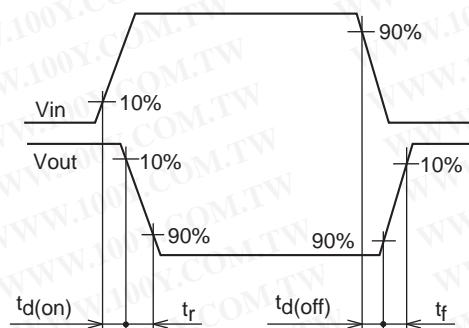
Normalized Transient Thermal Impedance vs. Pulse Width



Switching Time Test Circuit



Waveforms



Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]	
TO-3PBM	SC-93	PRSS0003ZA-A	TO-3PBM / TO-3PFMV	5.2g	Unit: mm

Ordering Information

Orderable Part No.	Quantity	Shipping Container
2SK2225-E	360 pcs	Box (Tube)

勝特力材料 886-3-5753170
胜特力电子(上海) 86-21-34970699
胜特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)